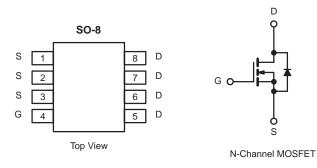


### TSM4936DCS-VB Datasheet

## N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.016 at V <sub>GS</sub> = 10 V	6.8	9.2 nC		
30	0.029 at $V_{GS}$ = 4.5 V	5.8	9.2 110		



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
   Definition
- Trench Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Notebook Load Switch
- Low Current dc-to-dc



Available

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	30	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		6.8 <sup>a</sup>		
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		5 <sup>a</sup>		
Continuous Drain Current $(T_j = 150^{\circ} C)$	T <sub>A</sub> = 25 °C		6.5 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		4.9 <sup>b,c</sup>	A	
Pulsed Drain Current	I <sub>DM</sub>	30			
Continuous Courses Davis Diada Current	T <sub>C</sub> = 25 °C		2.7		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.7 <sup>b,c</sup>		
	T <sub>C</sub> = 25 °C		4.1		
Maximum Davida Disaination	T <sub>C</sub> = 70 °C		2.6		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 <sup>b,c</sup>	W	
	T <sub>A</sub> = 70 °C		1.25 <sup>b,c</sup>		
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	45	62.5	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	25	30	0/11	

Notes:

a. Package Limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 110 °C/W.

9	3	® V]	Bs	em	i
W	ww.\	/Bs	em	i.cor	n

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		33		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = 250 μA		- 6.2		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		3	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current	1	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	1 C 10			
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			A
	P	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		0.016		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$		0.029		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5 A		24		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			1295		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		170		
Reverse Transfer Capacitance	C <sub>rss</sub>			72		
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		21.8	33	nC
				9.2	14	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$		3.8		
Gate-Drain Charge	Q <sub>gd</sub>			2.5		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		2.4		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			21	40	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		14	25	1
Turn-Off DelayTime	t <sub>d(off)</sub>	${ m I}_{ m D}\cong$ 5 A, ${ m V}_{ m GEN}$ = 4.5 V, ${ m R}_{ m g}$ = 1 $\Omega$		20	40	
Fall Time	t <sub>f</sub>	-		9	18	
Turn-On Delay Time	t <sub>d(on)</sub>			10	20	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		8	16	-
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ 5 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		21	35	
Fall Time	t <sub>f</sub>	-		8	16	
Drain-Source Body Diode Characterist	ics					
Continous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			2.7	_
Pulse Diode Forward Current	I <sub>SM</sub>				30	A
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 1.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.77	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			21	40	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$L = 2.0  dt/dt = 100.04  trace{T} = 25.90$		15	30	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		13		
Reverse Recovery Rise Time	t <sub>b</sub>			8		ns

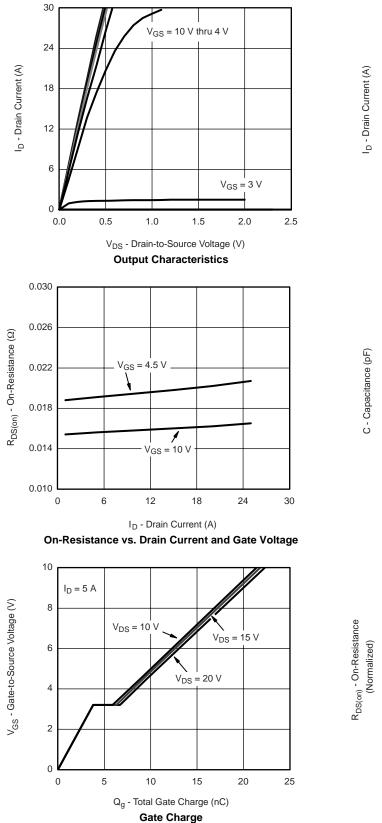
Notes:

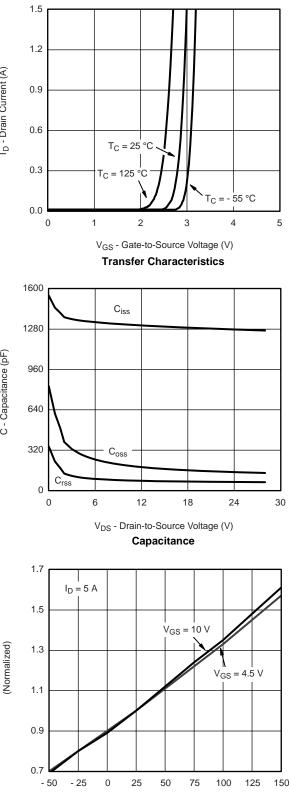
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



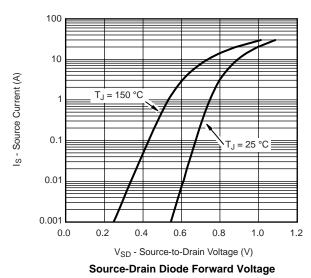


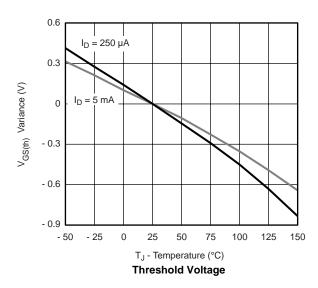


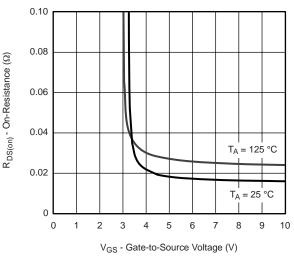
T<sub>J</sub> - Junction Temperature (°C)

**On-Resistance vs. Junction Temperature** 

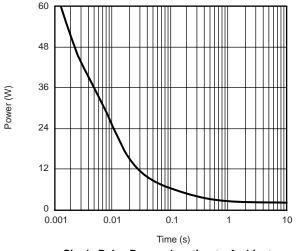




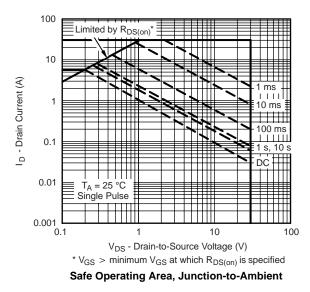




**On-Resistance vs. Gate-to-Source Temperature** 

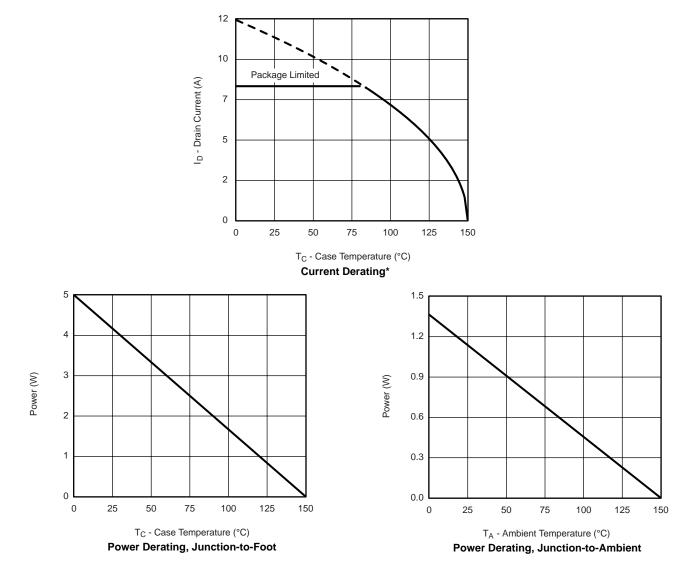


Single Pulse Power, Junction-to-Ambient



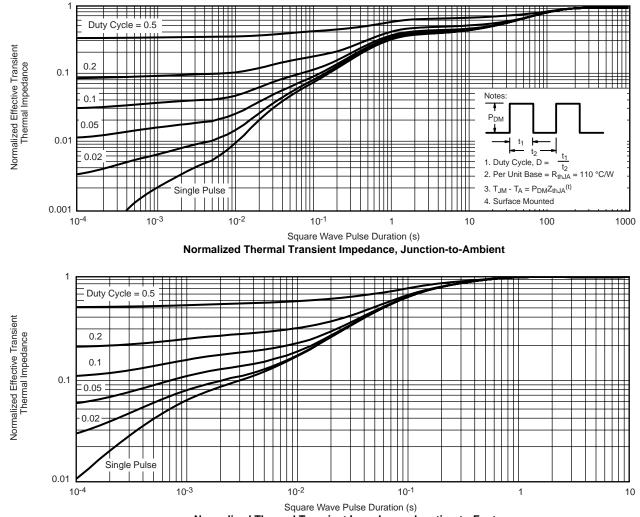
服务热线:400-655-8788





\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





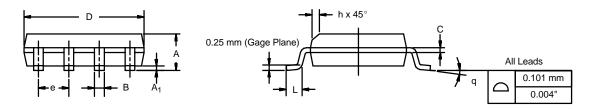
Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

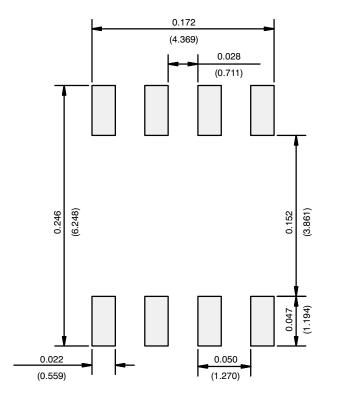




	MILLIMETERS		INC	HES		
DIM	Min	Max	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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